

Is Now Part of



# **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="https://www.onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese



## FDMS3626S PowerTrench<sup>®</sup> Power Stage 25V Asymmetric Dual N-Channel MOSFET

#### Features

Q1: N-Channel

- Max  $r_{DS(on)}$  = 5.0 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 17.5 A
- Max  $r_{DS(on)}$  = 5.7 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 16 A

Q2: N-Channel

- Max  $r_{DS(on)}$  = 2.6 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 25 A
- Max r<sub>DS(on)</sub> = 3.2 mΩ at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 22 A
- Low inductance packaging shortens rise/fall times, resulting in lower switching losses
- MOSFET integration enables optimum layout for lower circuit inductance and reduced switch node ringing
- RoHS Compliant

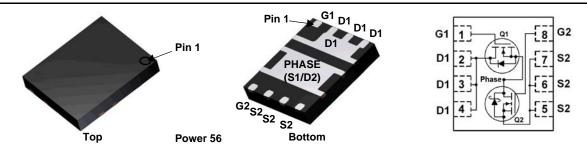


## **General Description**

This device includes two specialized N-Channel MOSFETs in a dual PQFN package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous SyncFET (Q2) have been designed to provide optimal power efficiency.

#### **Applications**

- Computing
- Communications
- General Purpose Point of Load
- Notebook VCORE



#### MOSFET Maximum Ratings TA = 25 °C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units	
V <sub>DS</sub>	Drain to Source Voltage		25	25	V	
V <sub>GS</sub>	Gate to Source Voltage	(Note 4)	±12	±12	V	
	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C	30	55		
I <sub>D</sub>	-Continuous	T <sub>A</sub> = 25 °C	17.5 <sup>1a</sup>	25 <sup>1b</sup>	A	
	-Pulsed		70	100		
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	29	45	mJ	
P <sub>D</sub>	Power Dissipation for Single Operation T <sub>A</sub> =		2.2 <sup>1a</sup>	2.5 <sup>1b</sup>	W	
	Power Dissipation for Single Operation	T <sub>A</sub> = 25 °C	1.0 <sup>1c</sup>	1.0 <sup>1d</sup>	vv	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to	+150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	57 <sup>1a</sup>	50 <sup>1b</sup>	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	125 <sup>1c</sup>	120 <sup>1d</sup>	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.0	3.0	

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
08OD 10OD	FDMS3626S	Power 56	13 "	12 mm	3000 units

Ы
¥
S
ũ
62
S9
τ
9
S€
Ť
Ξ
e
<u>c</u>
₪
Τ
2
ve e
7
St
ac
e

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ $I_D = 1 \ m A, \ V_{GS} = 0 \ V$	Q1 Q2	25 25			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ \text{mA}$ , referenced to 25 °C	Q1 Q2		12 25		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	Q1 Q2			1 500	μΑ μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = 12 V/-8 V, $V_{DS}$ = 0 V	Q1 Q2			±100 ±100	nA nA
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu\text{A}$ $V_{GS} = V_{DS}, I_D = 1 \ \text{mA}$	Q1 Q2	0.8 1.1	1.2 1.4	2.0 2.2	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ \text{mA}$ , referenced to 25 °C	Q1 Q2		-4 -3		mV/°C
(DOC)	Drain to Source On Resistance		Q1		3.8 4.4 5.4	5.0 5.7 7.0	- mΩ
r <sub>DS(on)</sub>	Brain to Gource on Resistance		Q2		2.1 2.6 2.9	2.6 3.2 3.8	11152
9fs	Forward Transconductance	$V_{DS} = 5 V$ , $I_D = 17.5 A$ $V_{DS} = 5 V$ , $I_D = 25 A$	Q1 Q2		100 227		S
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance	Q1: V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V, f = 1 MHZ	Q1 Q2		1570 2545		pF
C <sub>oss</sub>	Output Capacitance	Q2:	Q1 Q2		448 716		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V, f = 1 MHZ	Q1 Q2		61 103		pF
R <sub>g</sub>	Gate Resistance		Q1 Q2		0.4 0.9		Ω
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time		Q1 Q2		7 8		ns
t <sub>r</sub>	Rise Time	Q1: V <sub>DD</sub> = 13 V, I <sub>D</sub> = 17.5 A, R <sub>GEN</sub> = 6 Ω	Q1 Q2		2 4		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	Q2: V <sub>DD</sub> = 13 V, I <sub>D</sub> = 25 A, R <sub>GEN</sub> = 6 Ω	Q1 Q2 Q1		23 31		ns
t <sub>f</sub>	Fall Time				2 3		ns
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ Q1 $V_{DD} = 13 V$ ,	Q1 Q2		26 41		nC
Qg	Total Gate Charge	$V_{GS} = 0$ V to 4.5 V $I_D = 17.5$ A	Q1 Q2		12 19		nC
Q <sub>qs</sub>	Gate to Source Gate Charge	Q2	Q1		3.3		nC

Gate to Drain "Miller" Charge

 $\mathsf{Q}_\mathsf{gs}$ 

 $\mathsf{Q}_{\mathsf{gd}}$ 

nC

4.9

2.7

4.3

Q2

Q1

Q2

2

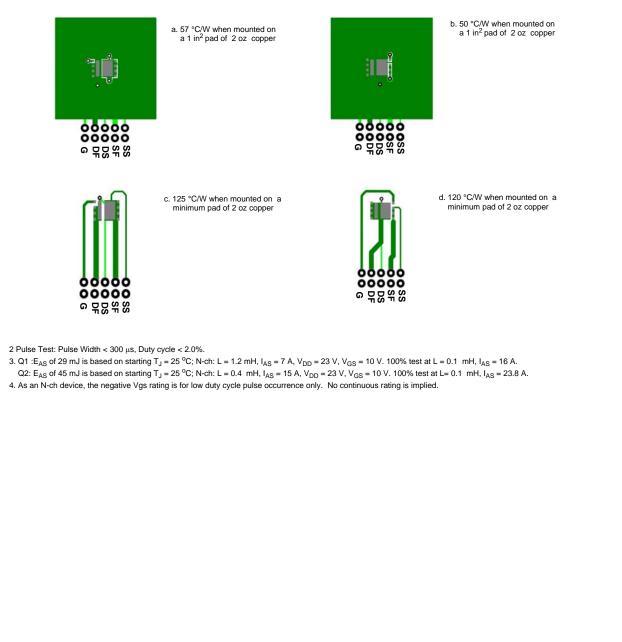
 $V_{DD} = 13 V,$  $I_{D} = 25 A$ 

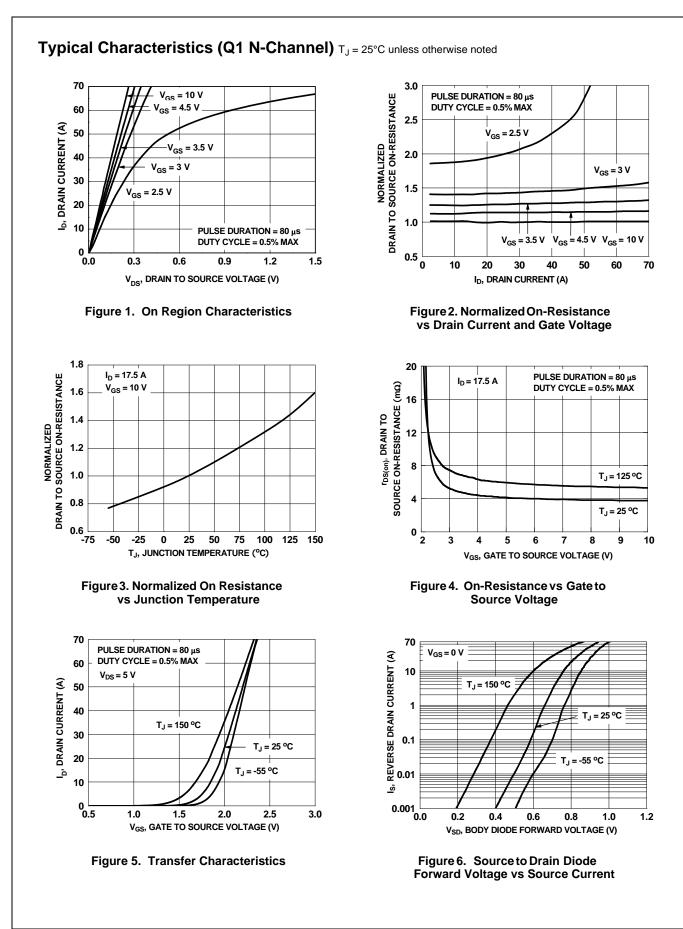
н
ž
ទ
362
26
õ
Р
S ₹
Ver
Ę.
er
<u>c</u>
۔ ®
D
o ≶
<u>ve</u>
ິດ
ita
ge

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-Sou	urce Diode Characteristics						
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 17.5 A$ (Note 2 $V_{GS} = 0 V, I_S = 25 A$ (Note 2	·		0.8 0.8	1.2 1.2	V
t <sub>rr</sub>	Reverse Recovery Time	Q1 I <sub>F</sub> = 17.5 A, di/dt = 100 A/μs	Q1 Q2		23 23		ns
Q <sub>rr</sub>	Reverse Recovery Charge	Q2 Ι <sub>F</sub> = 25 A, di/dt = 300 A/μs	Q1 Q2		9 22		nC

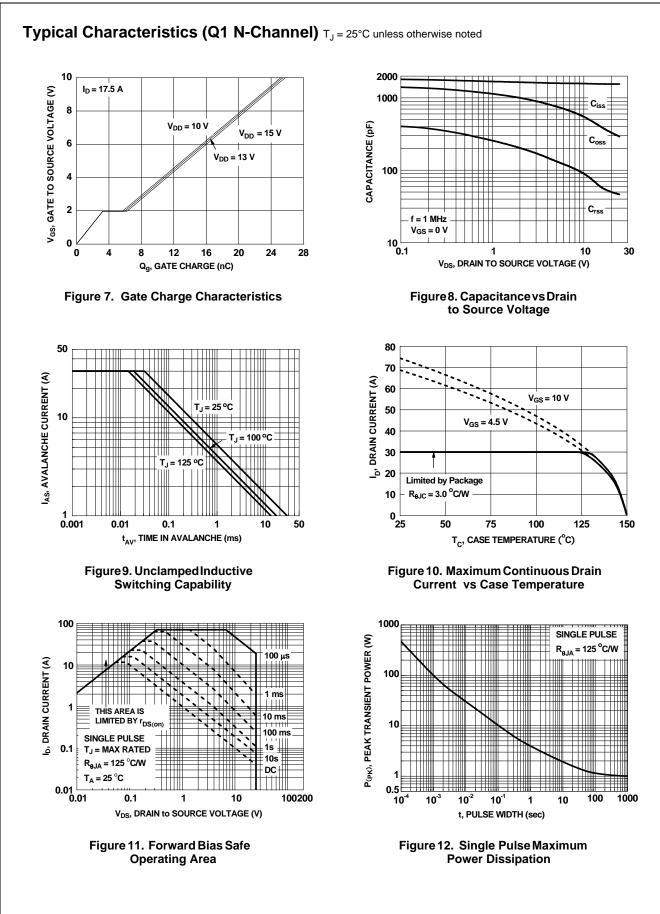
Notes

1.R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

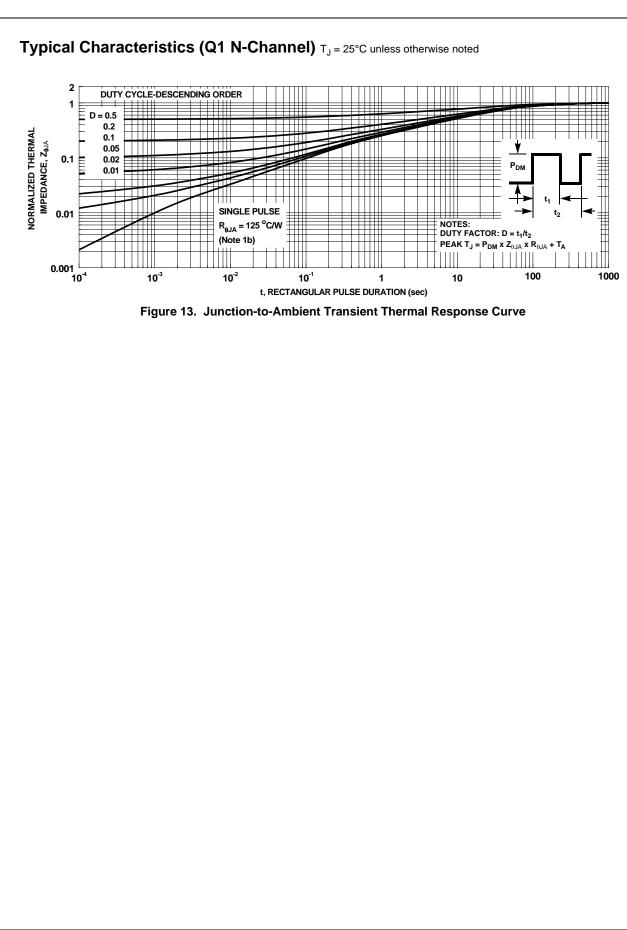


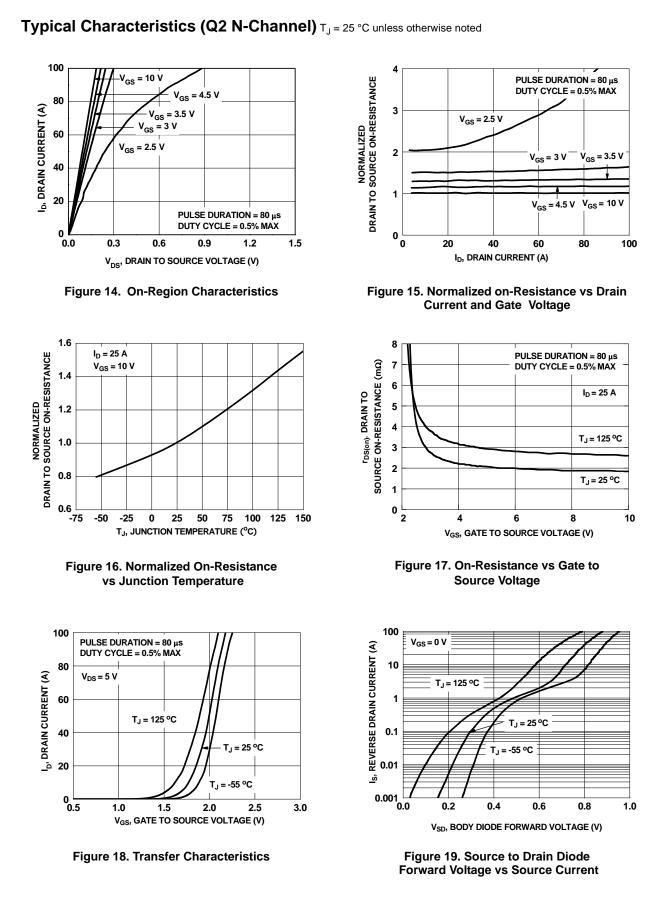


FDMS3626S PowerTrench<sup>®</sup> Power Stage

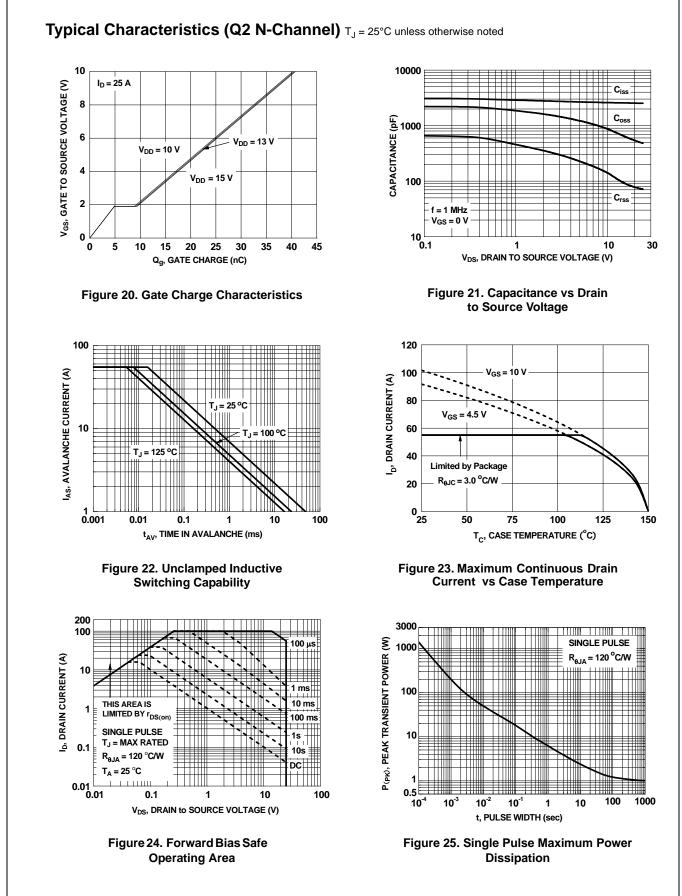




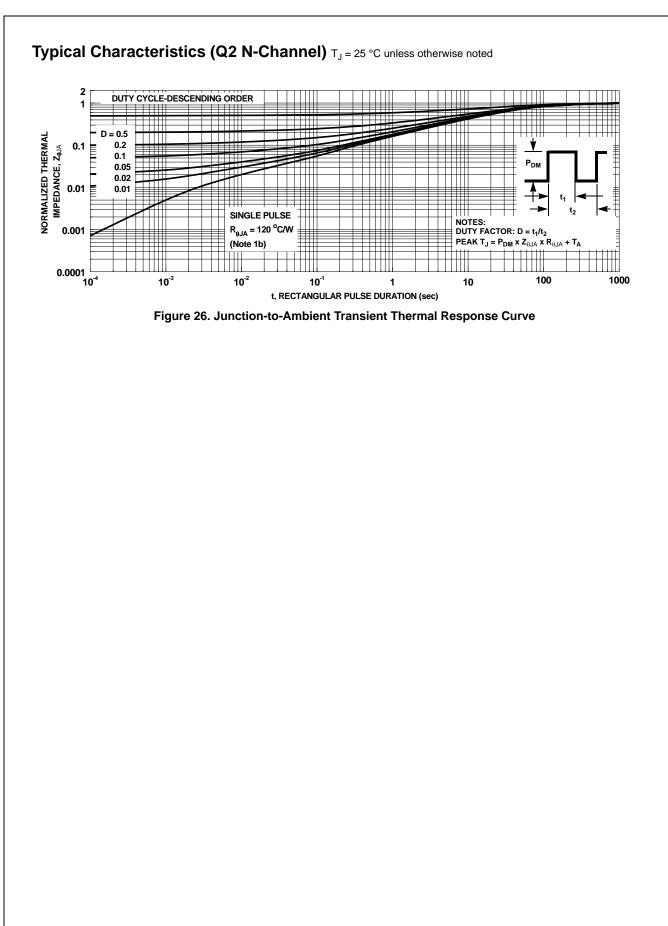








FDMS3626S PowerTrench<sup>®</sup> Power Stage



### Typical Characteristics (continued)

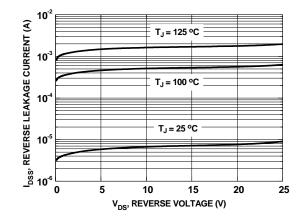
#### SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 27 shows the reverse recovery characteristic of the FDMS3626S.

30 25 20 CURRENT (A) 15 di/dt = 300 A/µs 10 5 0 -5 \_\_\_\_\_ 120 160 200 240 280 320 360 TIME (ns)

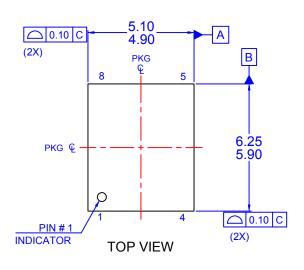
Figure 27. FDMS3626S SyncFET body diode reverse recovery characteristic

#### Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.



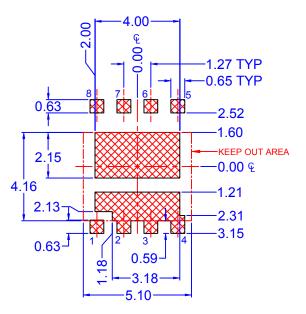
# Figure 28. SyncFET body diode reverse leakage versus drain-source voltage

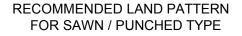
10

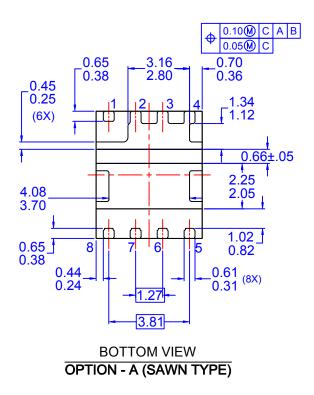


SEE

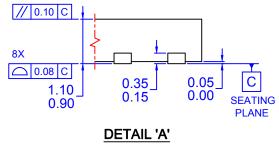
DETAIL A



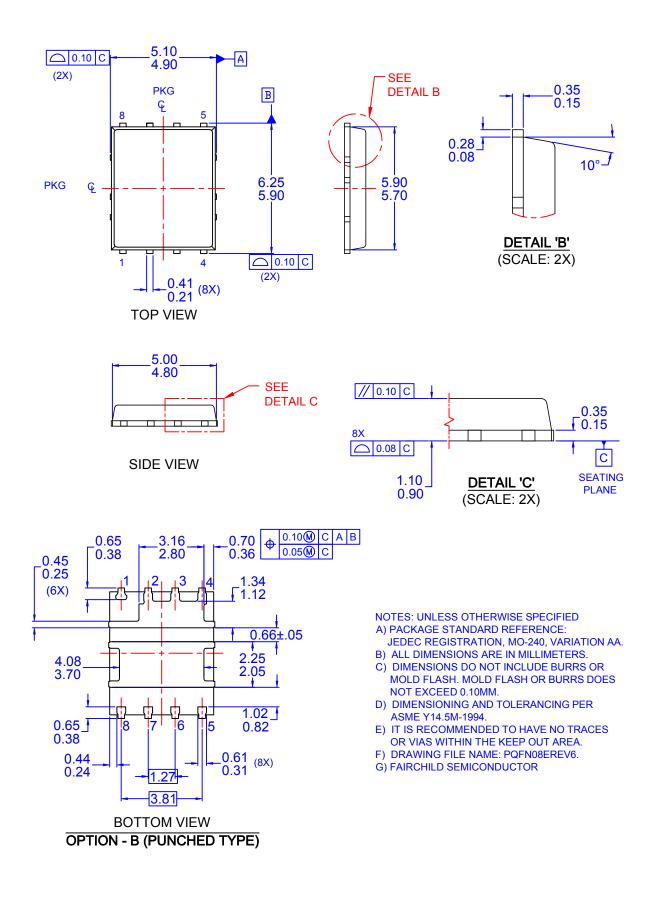




SIDE VIEW



(SCALE: 2X)



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC